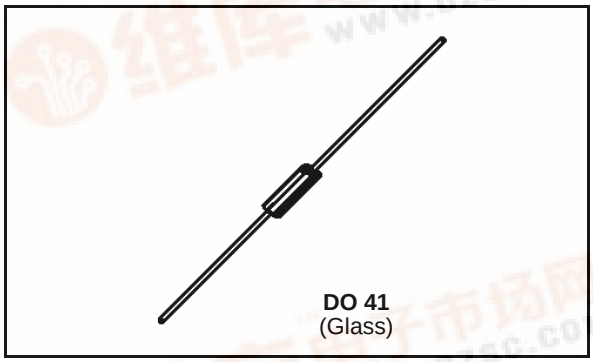
BYV 10-60

SMALL SIGNAL SCHOTTKY DIODE



DESCRIPTION

Metal to silicon rectifier diode in glass case featuring very low forward voltage drop and fast recovery time, intended for low voltage switching mode power supply, polarity protection and high frequency circuits.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive Peak Reverse Voltage		60	V
$I_{F(AV)}$	Average Forward Current*	T_{amb} = 25 °C	1	A
I_{FSM}	Surge non Repetitive Forward Current	T_{amb} = 25°C t_p = 10ms	20 Sinusoidal Pulse	A
		T_{amb} = 25°C t_p = 300µs	40 Rectangular Pulse	
T_{stg} T_j	Storage and Junction Temperature Range		- 65 to + 150 - 65 to + 125	°C °C
T_L	Maximum Lead Temperature for Soldering during 10s at 4mm from Case		230	°C

THERMAL RESISTANCE

Symbol	Test Conditions	Value	Unit
$R_{th(j-a)}$	Junction-ambient*	110	°C/W

* On infinite heatsink with 4mm lead length

ELECTRICAL CHARACTERISTICS

STATIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
I_R *	T_j = 25°C	$V_R = V_{RRM}$			0.5	mA
	T_j = 100°C				10	
V_F *	I_F = 1A	T_j = 25°C			0.7	V
	I_F = 3A				1	

DYNAMIC CHARACTERISTICS

Symbol	Test Conditions		Min.	Typ.	Max.	Unit
C	T_j = 25°C	V_R = 0		150		pF
	T_j = 25°C	V_R = 5V		40		

* Pulse test: $t_p \leq 300\mu s$ $\delta < 2\%$.

Forward current flow in a schottky rectifier is due to majority carrier conduction. So reverse recovery is not affected by stored charge as in conventional PN junction diodes.

Nevertheless, when the device switches from forward biased condition to reverse blocking state, current is required to charge the depletion capacitance of the diode.

This current depends only of diode capacitance and external circuit impedance. Satisfactory circuit behaviour analysis may be performed assuming that schottky rectifier consists of an ideal diode in parallel with a variable capacitance equal to the junction capacitance (see fig. 5 page 4/4).

Figure 1. Forward current versus forward voltage at low level (typical values).

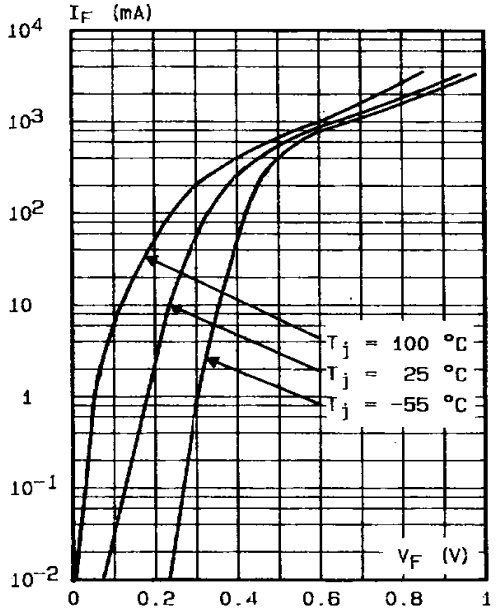


Figure 2. Forward current versus forward voltage at high level (typical values).

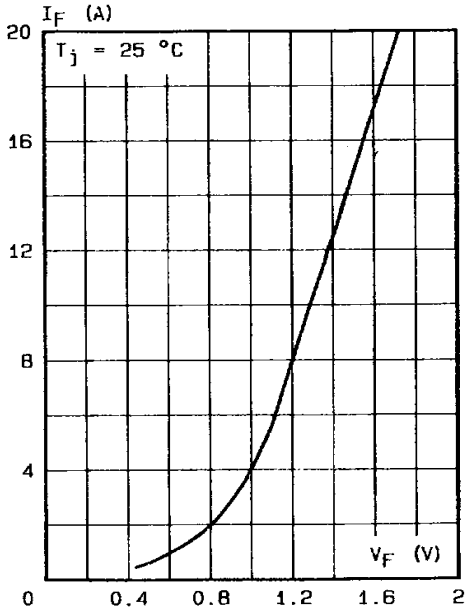


Figure 3. Reverse current versus junction temperature.

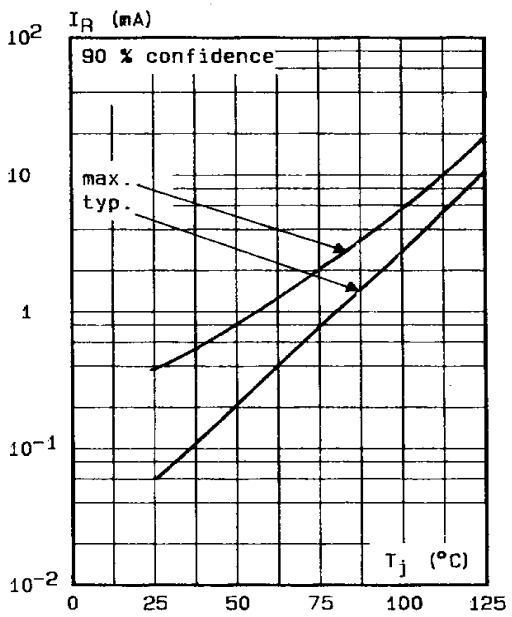


Figure 4. Reverse current versus V_{RRM} in per cent.

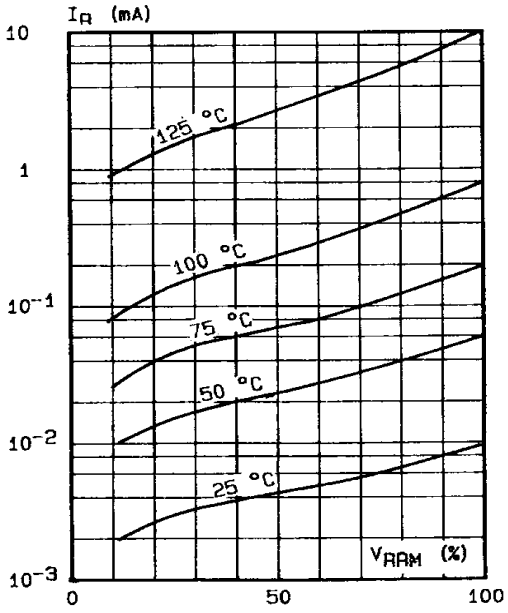


Figure 5. Capacitance C versus reverse applied voltage V_R (typical values).

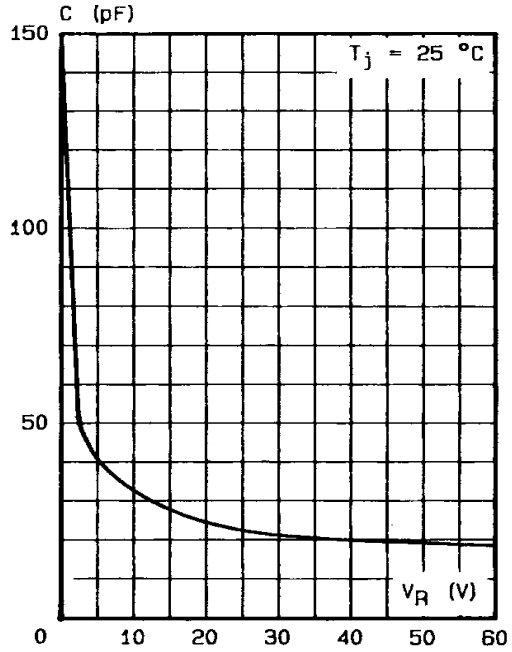


Figure 6. Surge non repetitive forward current for a rectangular pulse with t ≤ 10 ms.

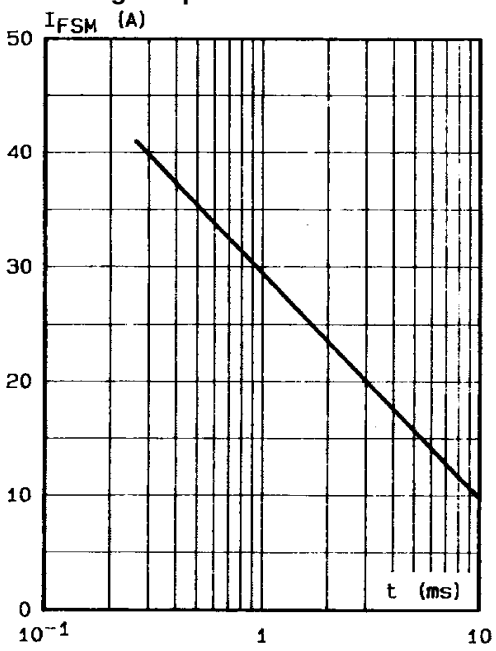
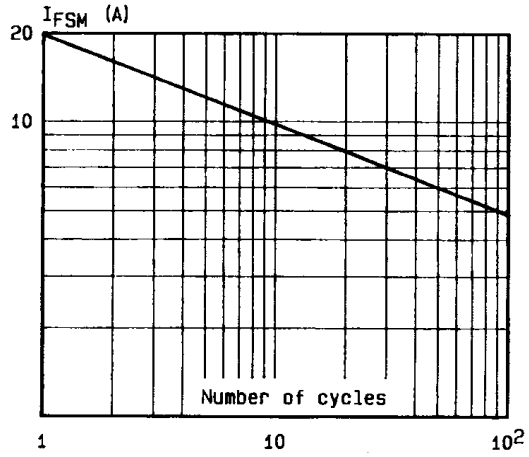
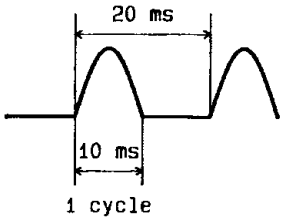


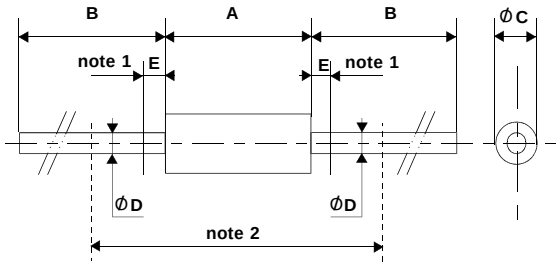
Figure 7. Surge non repetitive forward current versus number of cycles.





PACKAGE MECHANICAL DATA

DO 41 Glass



REF.	DIMENSIONS			
	Millimeters		Inches	
	Min.	Max.	Min.	Max.
A	4.07	5.20	0.160	0.205
B	2.04	2.71	0.080	0.107
C	28		1.102	
D	0.712	0.863	0.028	0.034

Cooling method : by convection and conduction
Marking: clear, ring at cathode end.
Weight: 0.34g